



DS4143-Î J | Â20FI ÁŞ > 31794)

FEATURES

- Double Side Cooling
- High Surge Capability
- Low Recovery Charge

Applications

- Induction Heating
- A.C. Motor Drives
- Inverters And Choppers
- Welding
- High Frequency Rectification
- UPS

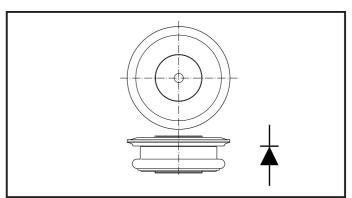
Voltage Ratings

Type Number	Repetitive Peak Reverse Voltage V _{RRM} V	Conditions
DF451 16	1600	$V_{RSM} = V_{RRM} + 100V$
DF451 14	1400	TOW THAN
DF451 12	1200	
DF451 10	1000	
DF451 08	800	
DF451 06	600	

V_{RRM} 1600V I_{F(AV)} 295A I_{FSM} 3500A

KEY PARAMETERS

25μC 1.22μs



Outline type code: M771.
See Package Details for further information.

CURRENT RATINGS

Symbol	Parameter	Conditions	Max.	Units				
Double Sic	Double Side Cooled							
I _{F(AV)}	Mean forward current	Half wave resistive load, T _{case} = 65°C		А				
I _{F(RMS)}	RMS value	T _{case} = 65°C	543	Α				
I _F	Continuous (direct) forward current	T _{case} = 65°C	391	А				
Single Side	e Cooled (Anode side)		•					
I _{F(AV)}	Mean forward current	Half wave resistive load, T _{case} = 65°C	220	А				
I _{F(RMS)}	RMS value	T _{case} = 65°C	348	А				
I _F	Continuous (direct) forward current	T _{case} = 65°C	285	А				

DF451

SURGE RATINGS

Symbol	Parameter	Conditions	Max.	Units
I _{FSM}	Surge (non-repetitive) forward current	10ms half sine; with 0% V T = 150°C	3.5	kA
l²t	I ² t for fusing	10ms half sine; with 0% V _{RRM,} T _j = 150°C	61.25 x 10 ³	A ² s
I _{FSM}	Surge (non-repetitive) forward current	10ms half sine; with 50% V T = 150°C	2.8	kA
l²t	I ² t for fusing	10ms half sine; with 50% V_{RRM} , $T_j = 150$ °C	39.2 x 10 ³	A ² s

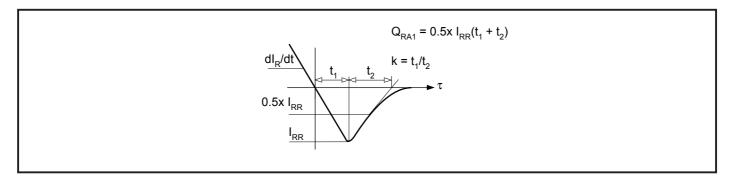
THERMAL AND MECHANICAL DATA

Symbol	Parameter	Conditions		-	Max.	Units
R _{th(j-c)}	Thermal resistance - junction to case	Double side cooled	dc	-	0.07	°C/W
		Single side cooled	Anode dc	-	0.133	°C/W
			Cathode dc	-	0.147	°C/W
R _{th(c-h)}	Thermal resistance - case to heatsink	Clamping force 5.0kN with mounting compound	Double side	-	0.02	°C/W
			Single side	-	0.02	°C/W
T _{vj}	Virtual junction temperature	Forward (conducting)		-	150	°C
T _{stg}	Storage temperature range			– 55	150	°C
-	Clamping force			4.5	5.5	kN

CHARACTERISTICS

Symbol	Parameter	Conditions	Тур.	Max.	Units
$V_{\sf FM}$	Forward voltage	At 600A peak, T _{case} = 25°C	-	2.65	V
I _{RRM}	Peak reverse current	At V _{RRM} , T _{case} = 125°C	-	100	mA
t _{rr}	Reverse recovery time		1.22	-	μs
Q _{RA1}	Recovered charge (50% chord)	$I_F = 500A$, $di_{RR}/dt = -80A/\mu s$	-	25	μС
I _{RM}	Reverse recovery current	$T_{case} = 125^{\circ}C, V_{R} = 100V$	-	40	А
К	Soft factor		1.7	-	-
V _{TO}	Threshold voltage	At T _{vj} = 125°C	-	1.6	V
r _T	Slope resistance	At T _{vj} = 125°C	-	1.5	mΩ
$V_{_{\mathrm{FRM}}}$	Forward recovery voltage	di/dt = 1000A/μs, T _j = 125°C	-	40	V

DEFINITION OF K FACTOR AND $\boldsymbol{Q}_{\text{RA1}}$



CURVES

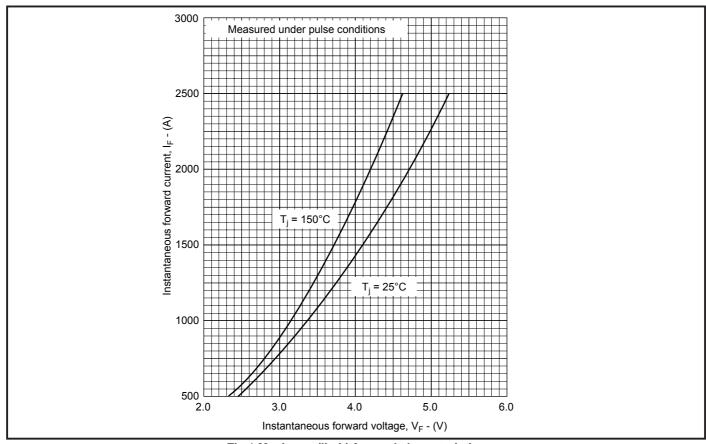


Fig.1 Maximum (limit) forward characteristics

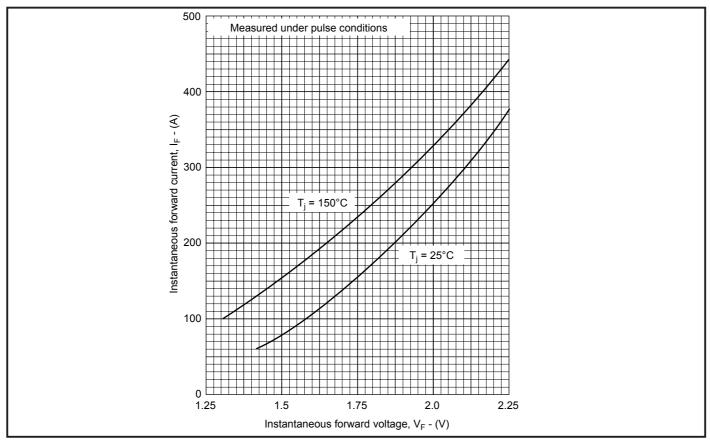


Fig.2 Maximum (limit) forward characteristics

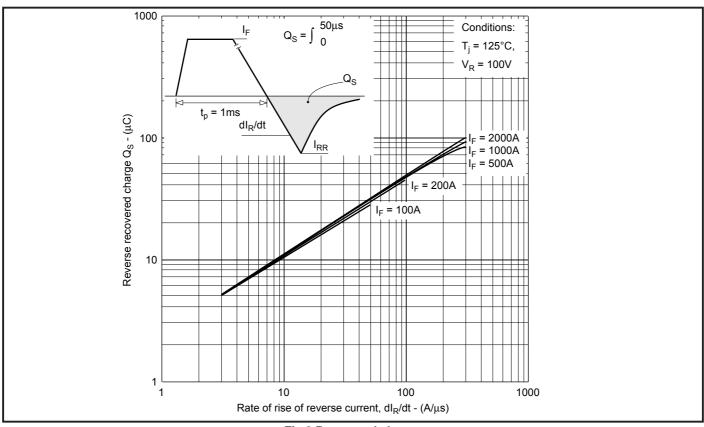


Fig.3 Recovered charge

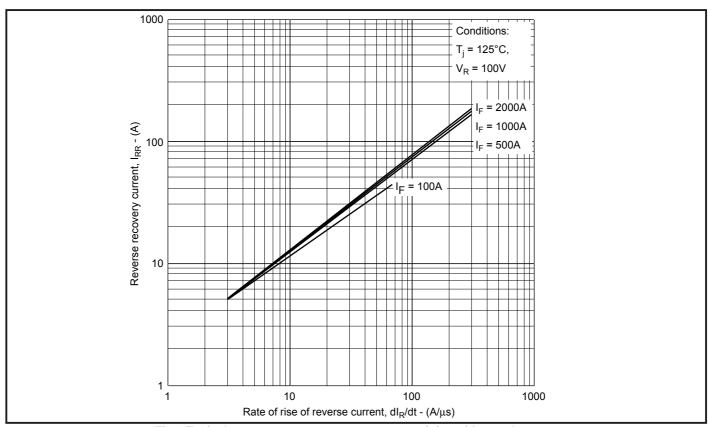


Fig.4 Typical reverse recovery current vs rate of rise of forward current

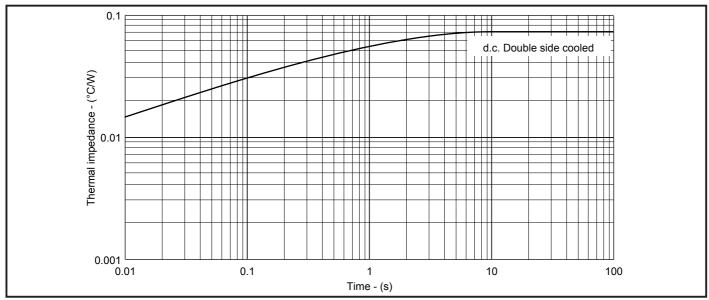
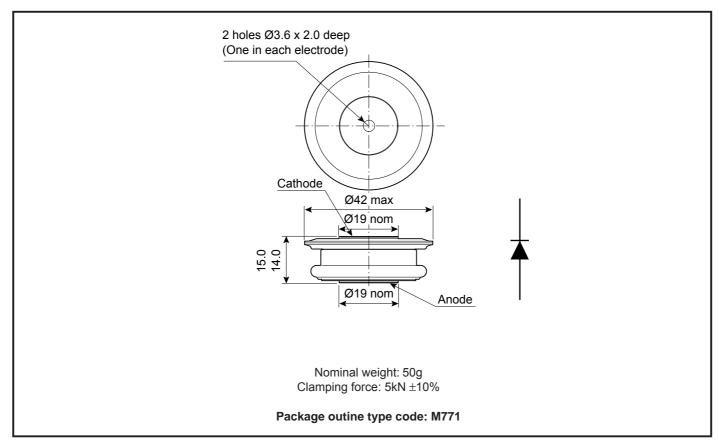


Fig.5 Maximum (limit) transient thermal impedance - junction to case - (°C/W)

PACKAGE DETAILS

For further package information, please contact your local Customer Service Centre. All dimensions in mm, unless stated otherwise. DO NOT SCALE.





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